ROHM

UMD25N

General purpose (dual digital transistor)

<For DTr1(NPN)>

Parameter	Value
V _{CC}	50V
I _{C(MAX.)}	100mA
R ₁	2.2kΩ
R ₂	47kΩ

• Outline SOT-363 SC-88

UMT6

<For DTr2(PNP)>

Parameter	Value
V _{CC}	-50V
I _{C(MAX.)}	-100mA
R ₁	2.2kΩ
R ₂	47kΩ

Features

- 1)Both the DTA123J chip and DTC123J chip in a UMT package.
- 2)Mounting possible with UMT3 automatic mounting machines.
- 3)Transistor elements are independent, eliminating interference.
- 4)Mounting cost and area can be cut in half.

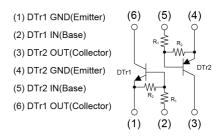
Application

INVERTER, INTERFACE, DRIVER

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
UMD25N	SOT-363 (UMT6)	2021	TR	180	8	3000	D25

Inner circuit



• Absolute maximum ratings ($T_a = 25^{\circ}C$)

Parameter	Symbol	DTr1(NPN)	DTr2(PNP)	Unit
Supply voltage	V _{CC}	50	-50	V
Input voltage	V _{IN}	-5 to 12	-12 to 5	V
Output current	Ι _ο	100	-100	mA
Collector current	I _{C(MAX)} *1	100	-100	mA
Power dissipation	P _D *2*3	150 n		mW/Total
Junction temperature	Tj	150		°C
Range of storage temperature	T _{stg}	-55 to +150		°C

•Electrical characteristics (T_a = 25°C) <For DTr1(NPN)>

Perameter	Symbol	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Inputvaltago	V _{I(off)}	V _{CC} = 5V, I _O = 100µA	-	-	0.5	M	
Input voltage	V _{I(on)}	$V_{\rm O} = 0.3$ V, $I_{\rm O} = 5$ mA 1.1		-	-	V	
Output voltage	V _{O(on)}	I _O = 5mA, I _I = 0.25mA	-	100	300	mV	
Input current		V ₁ = 5V	-	-	3.6	mA	
Output current	I _{O(off)}	$V_{CC} = 50V, V_{I} = 0V$	-	-	500	nA	
DC current gain	Gı	V _O = 5V, I _O = 10mA	80	-	-	-	
Input resistance R ₁		-	1.54	2.2	2.86	kΩ	
Resistance ratio R ₂ /R ₁		-	17	21	26	-	
Transition frequency	f _T *1	V _{CE} = 10V, I _E = -5mA, f = 100MHz	-	250	-	MHz	

•Electrical characteristics (T_a = 25°C) <For DTr2(PNP)>

Parameter	Symbol	Conditions	Values			Unit	
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
	V _{I(off)}	V _{CC} = -5V, I _O = -100µA	-	-	-0.5	V	
Input voltage	V _{I(on)}	$V_{\rm O} = -0.3V, I_{\rm O} = -5mA$ -1.1 -		-	-	V	
Output voltage	V _{O(on)}	I _O = -5mA, I _I = -0.25mA	-	-100	-300	mV	
Input current	I _I	V _I = -5V	-	-	-3.6	mA	
Output current	I _{O(off)}	$V_{CC} = -50V, V_{I} = 0V$	-	-	-500	nA	
DC current gain	GI	V _O = -5V, I _O = -10mA	80	-	-	-	
Input resistance	R ₁	-	1.54	2.2	2.86	kΩ	
Resistance ratio	R ₂ /R ₁	-	17	21	26	-	
Transition frequency	f _T *1	V _{CE} = -10V, I _E = 5mA, f = 100MHz	-	250	-	MHz	

*1 Characteristics of built-in transistor.

*2 Each terminal mounted on a reference and.

*3 120mW per element must not be exceeded.

*4 200mW per element must not be exceeded.



Vcc=5V

Pulsed

•Electrical characteristic curves(T_a = 25°C) <For DTR1(NPN)>

Fig.1 Input Voltage vs. Output Current

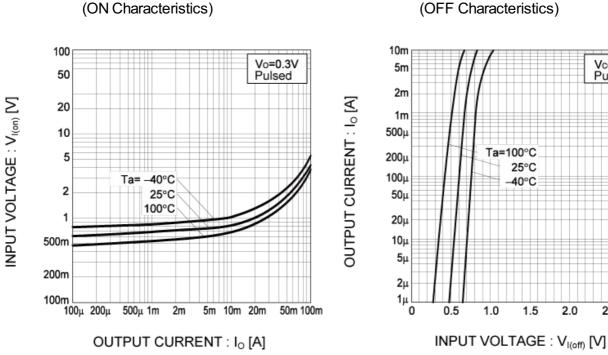


Fig.2 Output Current vs. Input Voltage (OFF Characteristics)

Ta=100°C

25°C

-40°C

1.5

2.0

2.5

3.0

Fig.4 DC Current Gain vs. Output Current

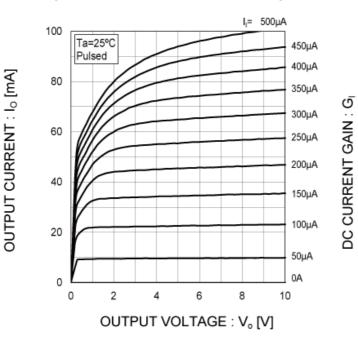
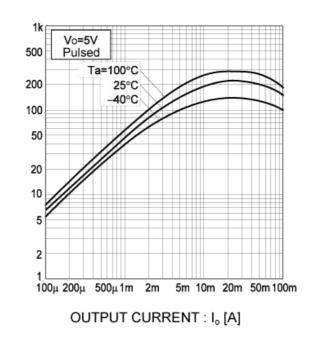


Fig.3 Output Current vs. Output Voltage





•Electrical characteristic curves(T_a = 25°C) <For DTR1(NPN)>

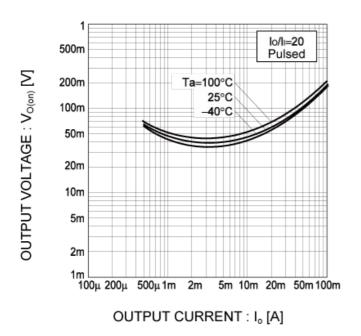


Fig.5 Output Voltage vs. Output Current



•Electrical characteristic curves(Ta=25°C) <For DTr2(PNP)>

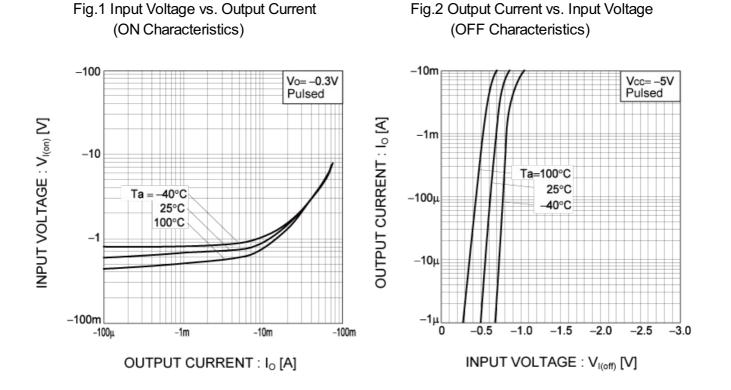


Fig.3 Output Current vs. Output Voltage

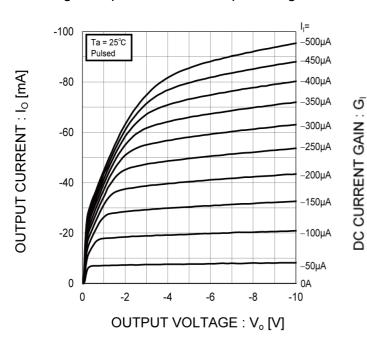
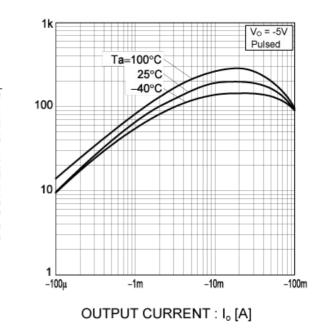
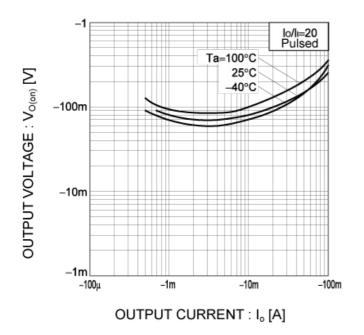


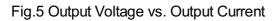
Fig.4 DC Current Gain vs. Output Current





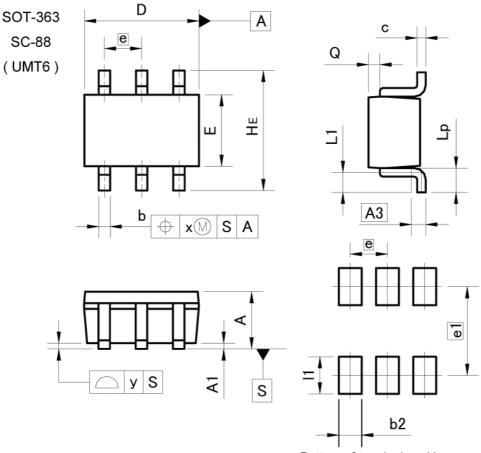
•Electrical characteristic curves(T_a=25°C) <For DTr2(PNP)>







Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES				
DIM	MIN	MAX	MIN	MAX				
A	0.80	1.00	0.031	0.039				
A1	0.00	0.10	0.000	0.004				
A3	0.3	25	0.010					
b	0.15	0.30	0.006	0.012				
С	0.10	0.20	0.004	0.008				
D	1.90	2.10	0.075	0.083				
E	1.15	1.35	0.045	0.053				
е	e 0.65		0.0	26				
HE	2.00	2.20	0.079	0.087				
L1	0.10	0.40	0.004	0.016				
Lp	0.25	0.55	0.010	0.022				
Q	0.10	0.30	0.004	0.012				
x	-	0.10	-	0.004				
У	-	0.10	-	0.004				
DIM		MILIMETERS		HES				
DIM	MIN	MAX	MIN	MAX				
b2	-	0.40	-	0.016				
e1	1.	55	0.061					
1	-	0.65	-	0.026				

Dimension in mm/inches



Notice

Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment ^(Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

	JAPAN	USA	EU	CHINA
ſ	CLASSⅢ		CLASS II b	
	CLASSⅣ	CLASSⅢ	CLASSⅢ	CLASSII

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
 - [a] Installation of protection circuits or other protective devices to improve system safety
 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
- 3. Our Products are designed and manufactured for use under standard conditions and not under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

Precaution for Foreign Exchange and Foreign Trade act

Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

Precaution Regarding Intellectual Property Rights

- All information and data including but not limited to application example contained in this document is for reference only. ROHM does not warrant that foregoing information or data will not infringe any intellectual property rights or any other rights of any third party regarding such information or data.
- 2. ROHM shall not have any obligations where the claims, actions or demands arising from the combination of the Products with other articles such as components, circuits, systems or external equipment (including software).
- 3. No license, expressly or implied, is granted hereby under any intellectual property rights or other rights of ROHM or any third parties with respect to the Products or the information contained in this document. Provided, however, that ROHM will not assert its intellectual property rights or other rights against you or your customers to the extent necessary to manufacture or sell products containing the Products, subject to the terms and conditions herein.

Other Precaution

- 1. This document may not be reprinted or reproduced, in whole or in part, without prior written consent of ROHM.
- 2. The Products may not be disassembled, converted, modified, reproduced or otherwise changed without prior written consent of ROHM.
- 3. In no event shall you use in any way whatsoever the Products and the related technical information contained in the Products or this document for any military purposes, including but not limited to, the development of mass-destruction weapons.
- 4. The proper names of companies or products described in this document are trademarks or registered trademarks of ROHM, its affiliated companies or third parties.

General Precaution

- 1. Before you use our Products, you are requested to care fully read this document and fully understand its contents. ROHM shall not be in an y way responsible or liable for failure, malfunction or accident arising from the use of a ny ROHM's Products against warning, caution or note contained in this document.
- 2. All information contained in this docume nt is current as of the issuing date and subj ect to change without any prior notice. Before purchasing or using ROHM's Products, please confirm the latest information with a ROHM sale s representative.
- 3. The information contained in this document is provided on an "as is" basis and ROHM does not warrant that all information contained in this document is accurate an d/or error-free. ROHM shall not be in an y way responsible or liable for any damages, expenses or losses incurred by you or third parties resulting from inaccuracy or errors of or concerning such information.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Bipolar Transistors - Pre-Biased category:

Click to view products by ROHM manufacturer:

Other Similar products are found below :

RN1607(TE85L,F) DTA124GKAT146 DTA144WETL DTA144WKAT146 DTC113EET1G DTC115TKAT146 DTC144ECA-TP DTC144VUAT106 MUN5241T1G BCR158WH6327XTSA1 NSBA114TDP6T5G NSBA143ZF3T5G NSBC114YF3T5G NSBC123TF3T5G SMUN5235T1G SMUN5330DW1T1G SSVMUN5312DW1T2G RN1303(TE85L,F) RN4605(TE85L,F) TTEPROTOTYPE79 DDTC114EUAQ-7-F EMH15T2R SMUN2214T3G NSBC114TF3T5G NSBC143ZPDP6T5G NSVMUN5113DW1T3G SMUN5230DW1T1G SMUN5133T1G SMUN2214T1G DTC114EUA-TP NSBA144EF3T5G NSVDTA114EET1G 2SC2223-T1B-A 2SC3912-TB-E SMUN5237DW1T1G SMUN5213DW1T1G SMUN5114DW1T1G SMUN2111T1G NSVDTC144EM3T5G DTC124ECA-TP DTC123TM3T5G DTA114ECA-TP DTA113EM3T5G DCX115EK-7-F DTC113EM3T5G NSVMUN5135DW1T1G NSVMUN2237T1G NSVDTC143ZM3T5G SMUN5335DW1T2G SMUN5216DW1T1G